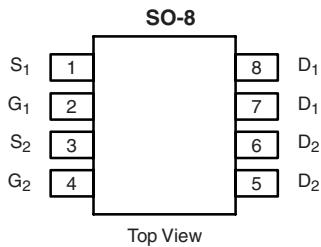


## N- and P-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY				
	V <sub>DS</sub> (V)	R <sub>D(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)
N-Channel	40	0.027 at V <sub>GS</sub> = 10 V	6.0	9.6
		0.032 at V <sub>GS</sub> = 4.5 V	4.8	
P-Channel	- 40	0.029 at V <sub>GS</sub> = - 10 V	- 6.0	21
		0.039 at V <sub>GS</sub> = - 4.5 V	- 4.9	



### FEATURES

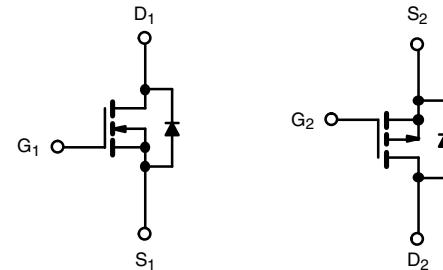
- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET® Power MOSFET
- 100 % R<sub>g</sub> and UIS Tested



**RoHS**  
COMPLIANT  
**HALOGEN**  
**FREE**  
Available

### APPLICATIONS

- CCFL Inverter



Ordering Information: Si4569DY-T1-E3 (Lead (Pb)-free)  
Si4569DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

P-Channel MOSFET

### ABSOLUTE MAXIMUM RATINGS T<sub>A</sub> = 25 °C, unless otherwise noted

Parameter	Symbol	N-Channel	P-Channel	Unit
Drain-Source Voltage	V <sub>DS</sub>	40	- 40	V
Gate-Source Voltage	V <sub>GS</sub>		± 16	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C	I <sub>D</sub>	7.6	
	T <sub>C</sub> = 70 °C		6.0	
	T <sub>A</sub> = 25 °C		6.0 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C		4.8 <sup>b, c</sup>	
Pulsed Drain Current (10 µs Pulse Width)	I <sub>DM</sub>	20	- 20	A
Source-Drain Current Diode Current	T <sub>C</sub> = 25 °C	I <sub>S</sub>	2.6	
	T <sub>A</sub> = 25 °C		1.6 <sup>b, c</sup>	
Pulsed Source-Drain Current	I <sub>SM</sub>	20	- 20	
Single Pulse Avalanche Current	I <sub>AS</sub>	10	20	
Single Pulse Avalanche Energy	E <sub>AS</sub>	5	20	mJ
Maximum Power Dissipation	T <sub>C</sub> = 25 °C	P <sub>D</sub>	3.1	
	T <sub>C</sub> = 70 °C		2	
	T <sub>A</sub> = 25 °C		2 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C		1.28 <sup>b, c</sup>	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		
				°C

### THERMAL RESISTANCE RATINGS

Parameter	Symbol	N-Channel		P-Channel		Unit
		Typ.	Max.	Typ.	Max.	
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	49	62.5	47	62.5
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	30	40	29	38

Notes:

- a. Based on T<sub>C</sub> = 25 °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 120 °C/W (N-Channel) and 110 °C/W (P-Channel).

**SPECIFICATIONS**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

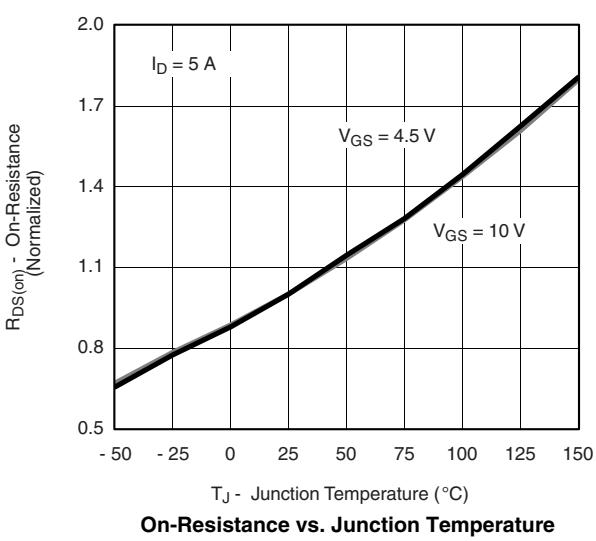
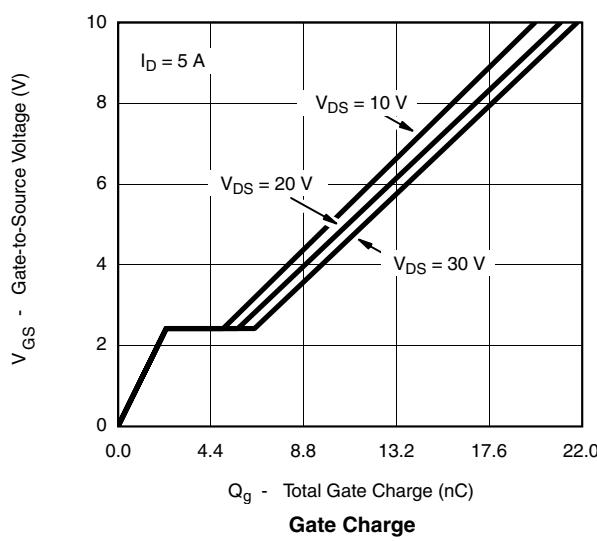
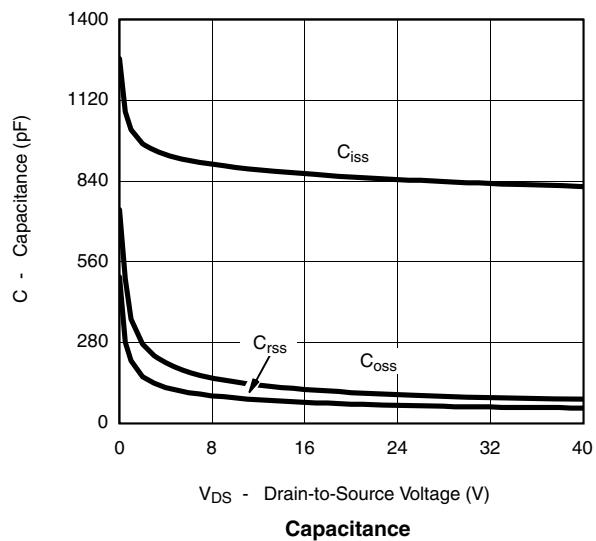
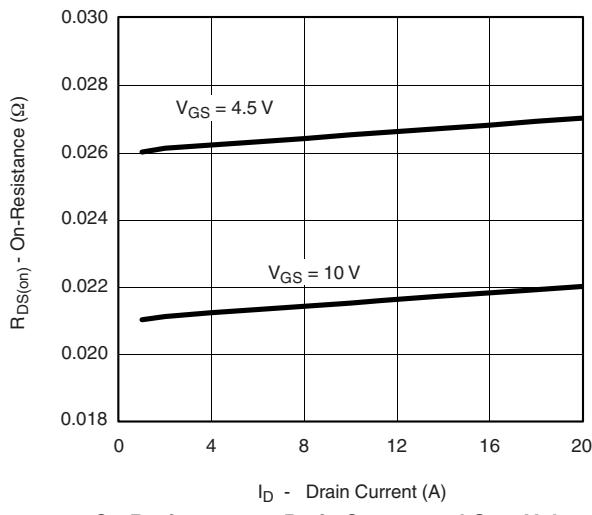
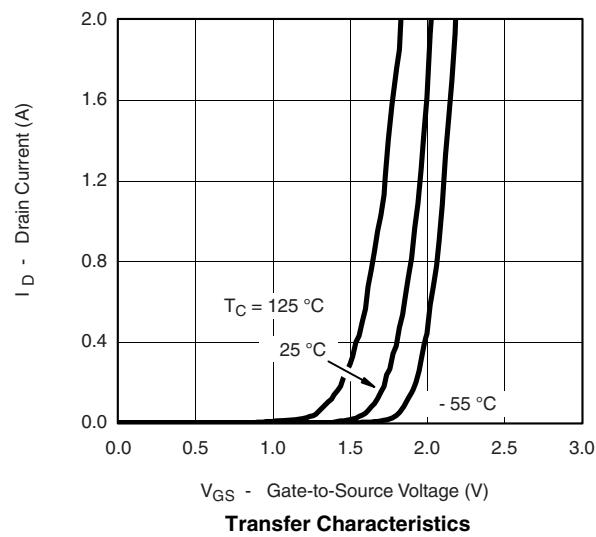
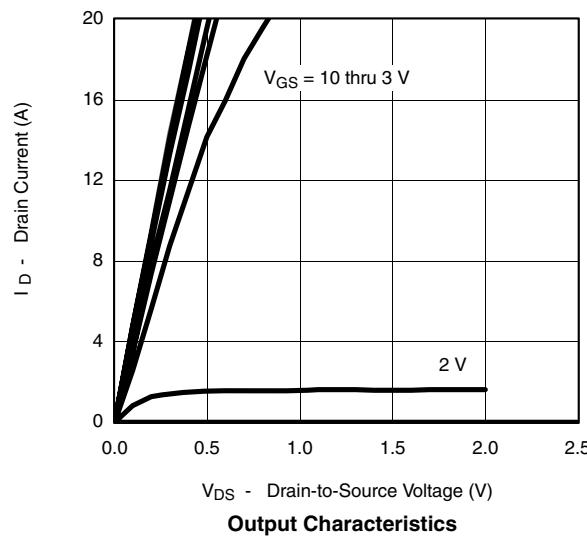
Parameter	Symbol	Test Conditions	Min.	Typ. <sup>a</sup>	Max.	Unit	
<b>Static</b>							
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	N-Ch	40			
		$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	P-Ch	- 40			
$V_{DS}$ Temperature Coefficient	$\Delta V_{DS}/T_J$	$I_D = 250 \mu\text{A}$	N-Ch	37		V	
		$I_D = -250 \mu\text{A}$	P-Ch	- 38			
$V_{GS(\text{th})}$ Temperature Coefficient	$\Delta V_{GS(\text{th})}/T_J$	$I_D = 250 \mu\text{A}$	N-Ch	- 5			
		$I_D = -250 \mu\text{A}$	P-Ch	4.0			
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	N-Ch	0.6	2.0		
		$V_{DS} = V_{GS}, I_D = -250 \mu\text{A}$	P-Ch	- 0.8	- 2.2		
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 16 \text{ V}$	N-Ch		100	nA	
			P-Ch		- 100		
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$	N-Ch		1	μA	
		$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}$	P-Ch		- 1		
		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^\circ\text{C}$	N-Ch		10		
		$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 55^\circ\text{C}$	P-Ch		- 10		
On-State Drain Current <sup>b</sup>	$I_{D(\text{on})}$	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	N-Ch	20		A	
		$V_{DS} = -5 \text{ V}, V_{GS} = -10 \text{ V}$	P-Ch	- 20			
Drain-Source On-State Resistance <sup>b</sup>	$R_{DS(\text{on})}$	$V_{GS} = 10 \text{ V}, I_D = 6 \text{ A}$	N-Ch		0.022	Ω	
		$V_{GS} = -10 \text{ V}, I_D = -6 \text{ A}$	P-Ch		0.024		
		$V_{GS} = 4.5 \text{ V}, I_D = 4.8 \text{ A}$	N-Ch		0.026		
		$V_{GS} = -4.5 \text{ V}, I_D = -4.9 \text{ A}$	P-Ch		0.031		
Forward Transconductance <sup>b</sup>	$g_{fs}$	$V_{DS} = 15 \text{ V}, I_D = 6 \text{ A}$	N-Ch		20	S	
		$V_{DS} = -15 \text{ V}, I_D = -6 \text{ A}$	P-Ch		17		
<b>Dynamic<sup>a</sup></b>							
Input Capacitance	$C_{iss}$	<p style="text-align: center;">N-Channel <math>V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}</math></p> <p style="text-align: center;">P-Channel <math>V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}</math></p>	N-Ch	855		pF	
			P-Ch	1505			
Output Capacitance	$C_{oss}$		N-Ch	105			
			P-Ch	230			
Reverse Transfer Capacitance	$C_{rss}$		N-Ch	65			
			P-Ch	175			
Total Gate Charge	$Q_g$	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$	N-Ch	21	32	nC	
		$V_{DS} = -20 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -5 \text{ A}$	P-Ch	41	62		
Gate-Source Charge	$Q_{gs}$	<p style="text-align: center;">N-Channel <math>V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}</math></p> <p style="text-align: center;">P-Channel <math>V_{DS} = -20 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -5 \text{ A}</math></p>	N-Ch	9.6	14.5		
			P-Ch	21	31		
Gate-Drain Charge	$Q_{gd}$		N-Ch	2.3			
			P-Ch	4.5			
Gate Resistance	$R_g$	$f = 1 \text{ MHz}$	N-Ch	3.2		Ω	
			P-Ch	9.2			

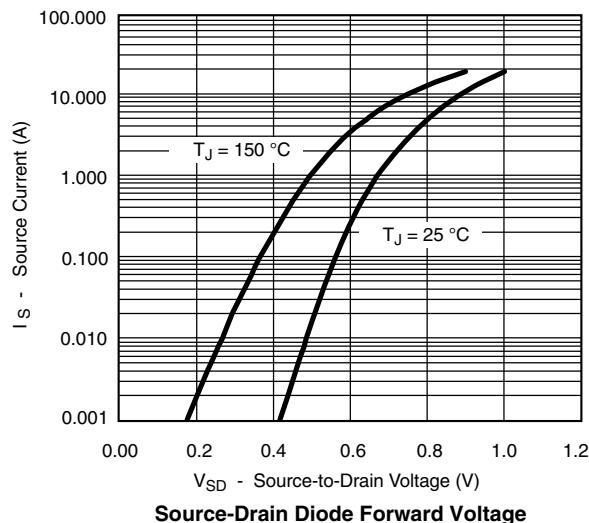
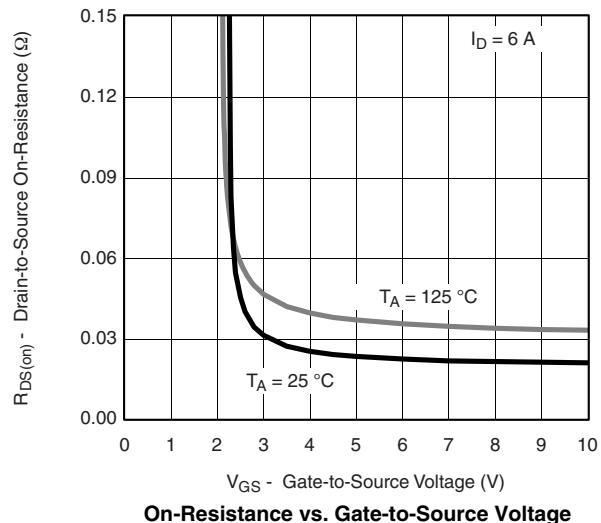
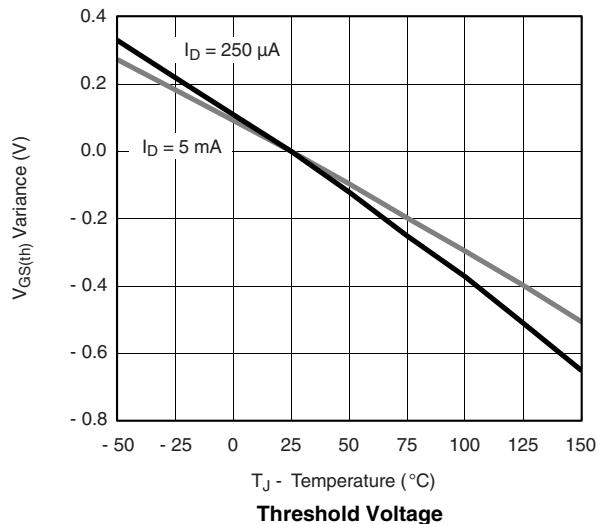
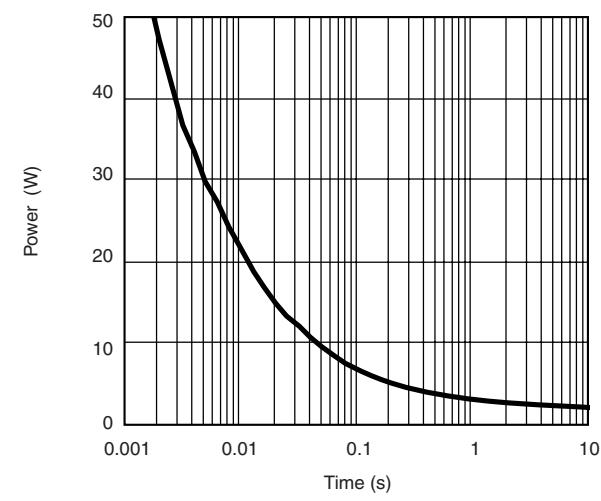
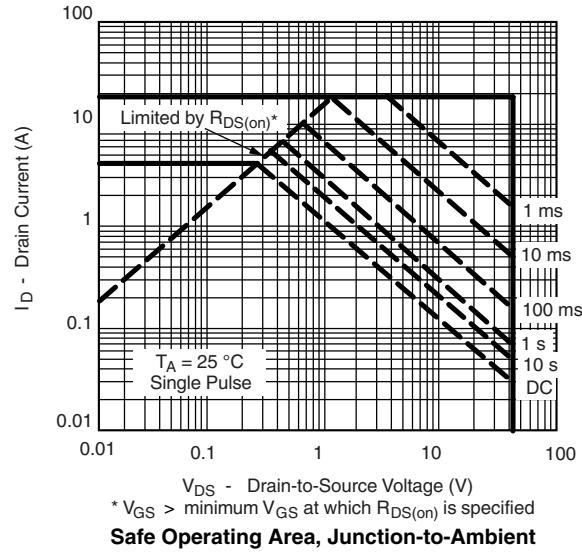
<b>SPECIFICATIONS</b> $T_J = 25^\circ\text{C}$ , unless otherwise noted								
Parameter	Symbol	Test Conditions			Min.	Typ. <sup>a</sup>	Max.	Unit
<b>Dynamic<sup>a</sup></b>								
Turn-On Delay Time	$t_{d(on)}$	N-Channel $V_{DD} = 20 \text{ V}$ , $R_L = 4 \Omega$ $I_D \approx 5 \text{ A}$ , $V_{GEN} = 10 \text{ V}$ , $R_g = 1 \Omega$  P-Channel $V_{DD} = -20 \text{ V}$ , $R_L = 4 \Omega$ $I_D \approx -5 \text{ A}$ , $V_{GEN} = -10 \text{ V}$ , $R_g = 1 \Omega$	N-Ch	6	12		ns	
Rise Time	$t_r$		P-Ch	7	14			
Turn-Off Delay Time	$t_{d(off)}$		N-Ch	11	20			
Fall Time	$t_f$		P-Ch	15	25			
Turn-On Delay Time	$t_{d(on)}$		N-Ch	24	36			
Rise Time	$t_r$		P-Ch	51	77			
Turn-Off Delay Time	$t_{d(off)}$		N-Ch	6	12			
Fall Time	$t_f$		P-Ch	54	81			
Continuous Source-Drain Diode Current	$I_S$	$T_C = 25^\circ\text{C}$ N-Channel $V_{DD} = 20 \text{ V}$ , $R_L = 4 \Omega$ $I_D \approx 5 \text{ A}$ , $V_{GEN} = 4.5 \text{ V}$ , $R_g = 1 \Omega$  P-Channel $V_{DD} = -20 \text{ V}$ , $R_L = 4 \Omega$ $I_D \approx -5 \text{ A}$ , $V_{GEN} = -4.5 \text{ V}$ , $R_g = 1 \Omega$	N-Ch	12	20		A	
Pulse Diode Forward Current <sup>a</sup>	$I_{SM}$		P-Ch	26	40			
Body Diode Voltage	$V_{SD}$		N-Ch	60	90			
Body Diode Reverse Recovery Time	$t_{rr}$		P-Ch	105	160			
Body Diode Reverse Recovery Charge	$Q_{rr}$		N-Ch	22	33			
Reverse Recovery Fall Time	$t_a$		P-Ch	60	90			
Reverse Recovery Rise Time	$t_b$		N-Ch	5	10			
			P-Ch	60	90			
<b>Drain-Source Body Diode Characteristics</b>								
Notes:								

- a. Guaranteed by design, not subject to production testing.  
 b. Pulse test; pulse width  $\leq 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .

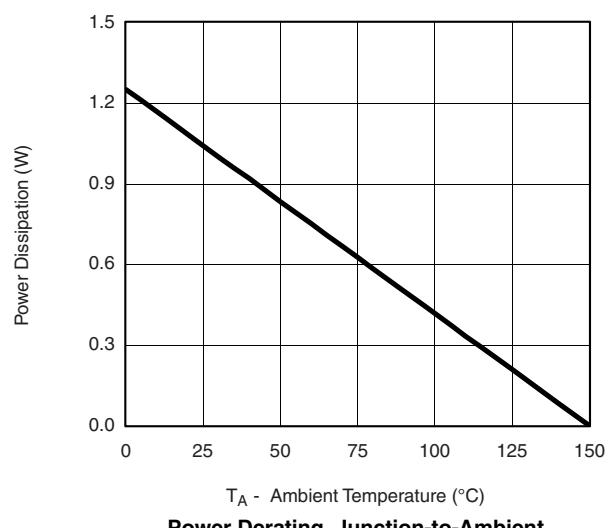
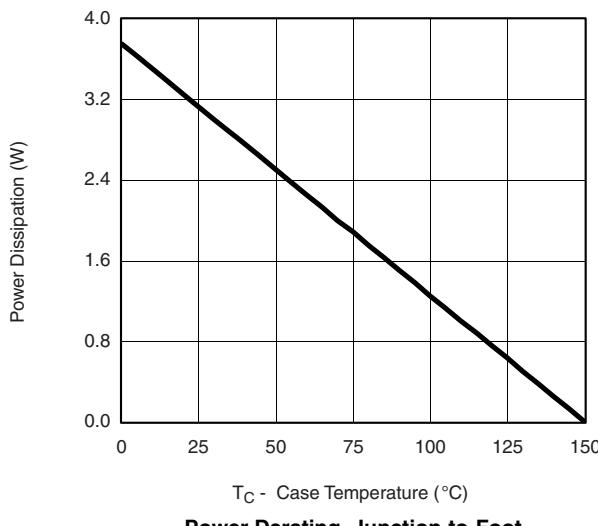
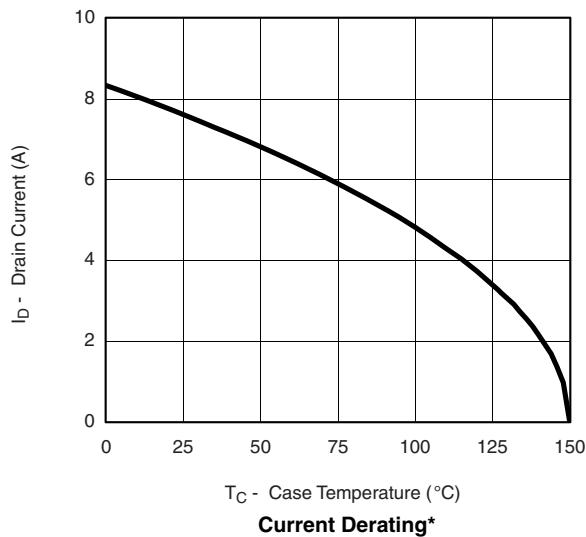
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

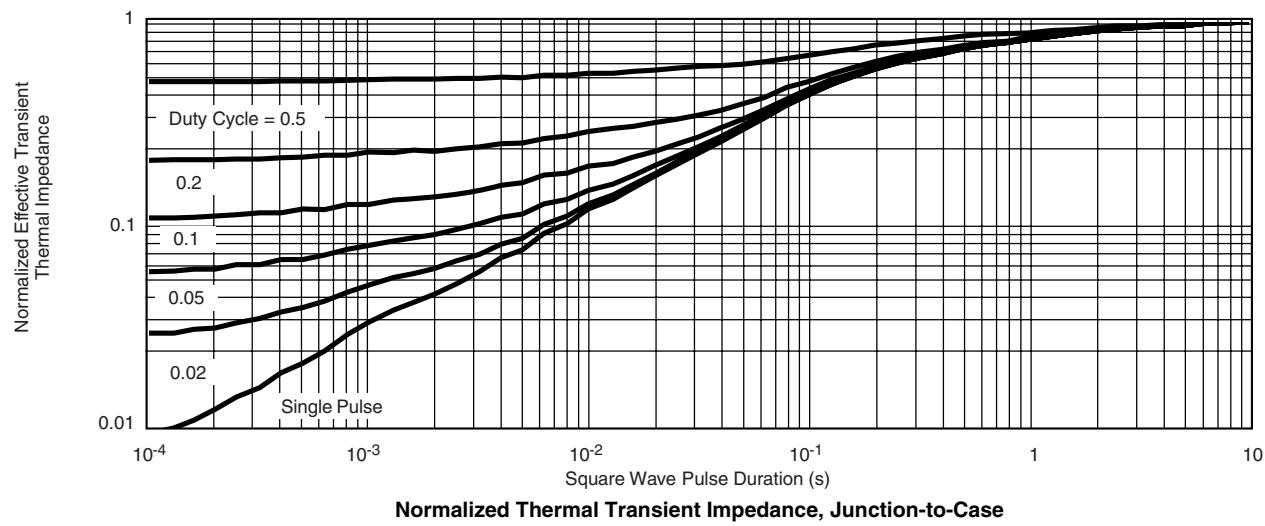
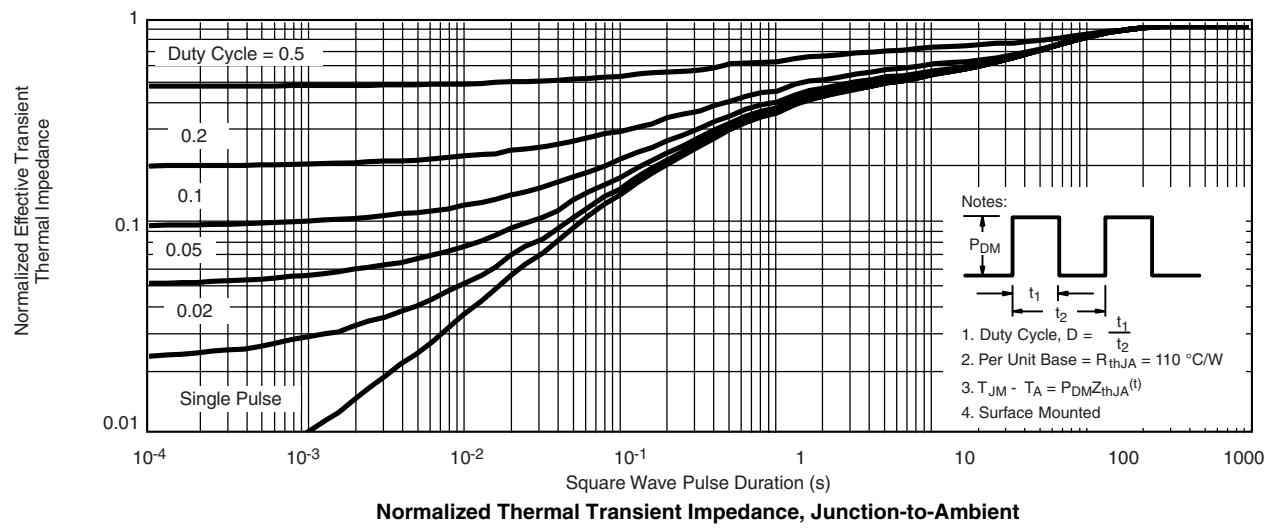


**N-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

**Source-Drain Diode Forward Voltage**

**On-Resistance vs. Gate-to-Source Voltage**

**Threshold Voltage**

**Single Pulse Power, Junction-to-Ambient**


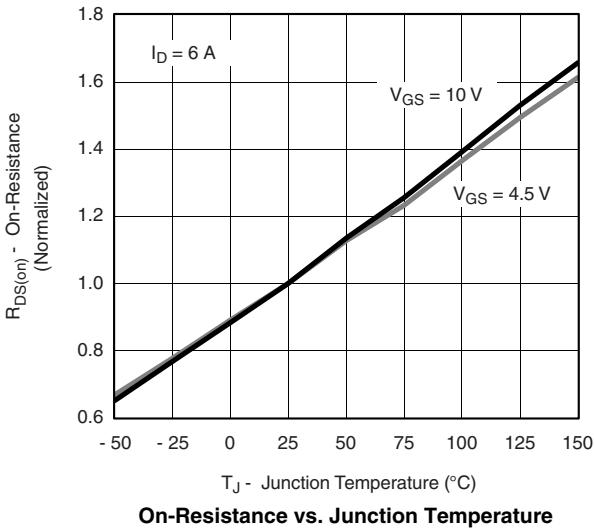
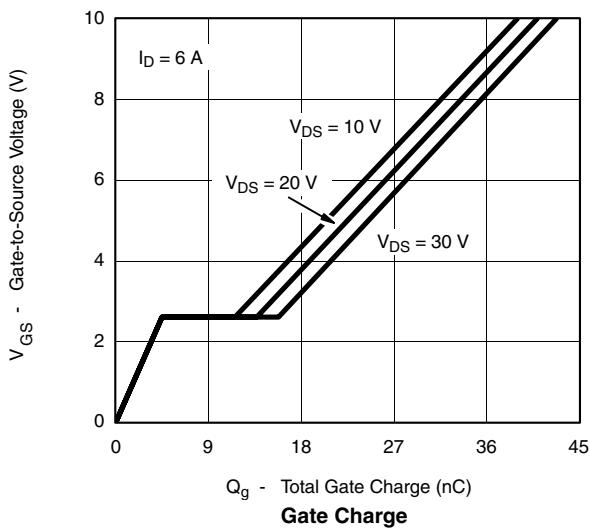
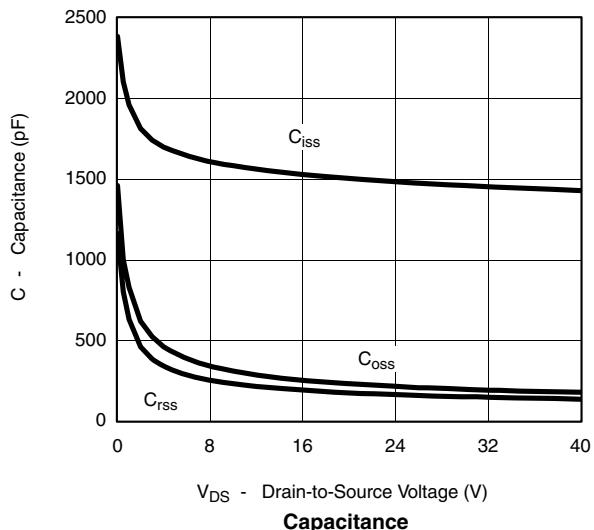
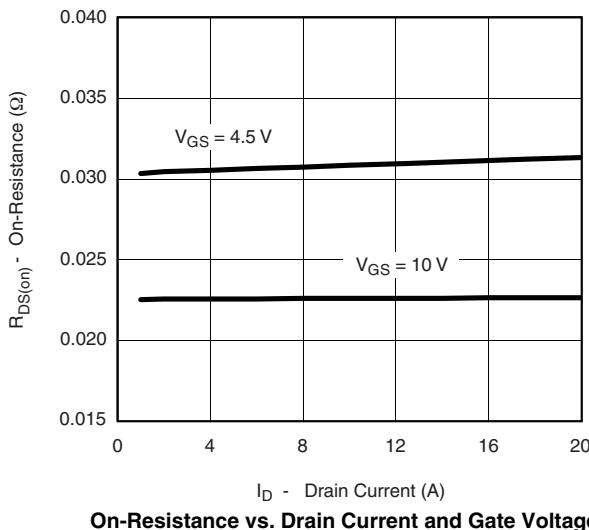
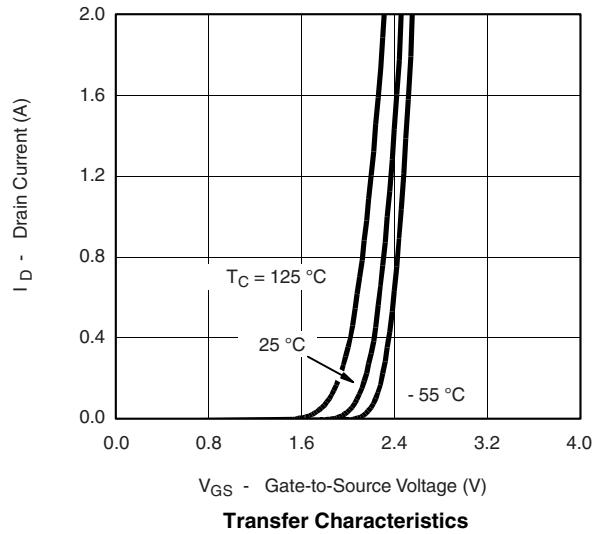
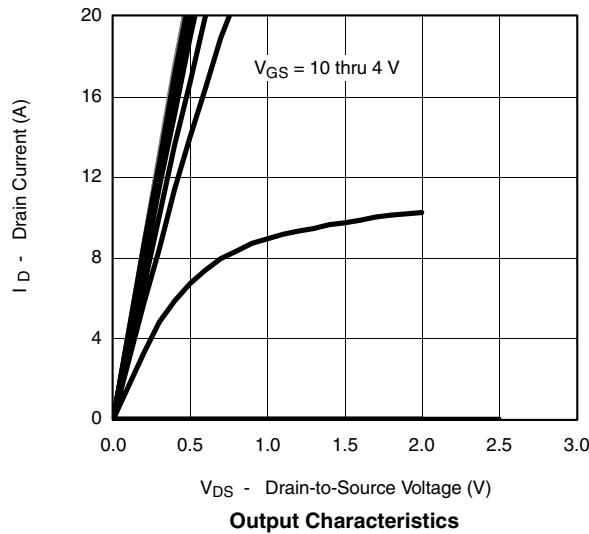
$* V_{GS} >$  minimum  $V_{GS}$  at which  $R_{DS(\text{on})}$  is specified  
**Safe Operating Area, Junction-to-Ambient**

**N-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

\* The power dissipation P<sub>D</sub> is based on T<sub>J(max)</sub> = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

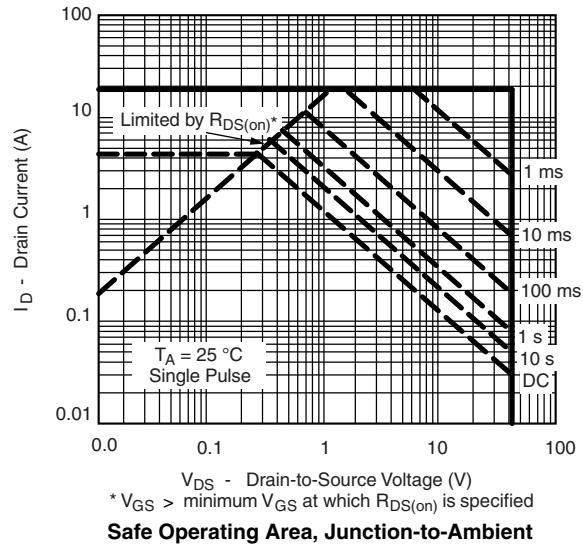
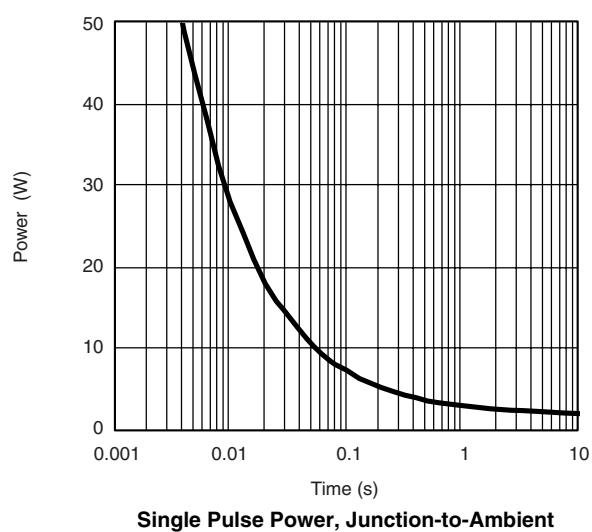
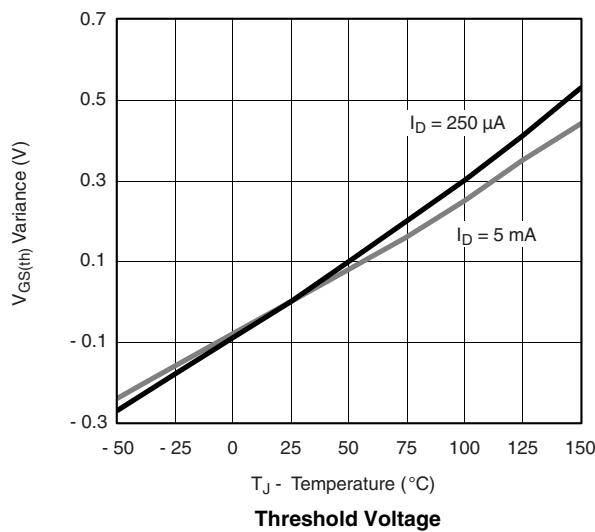
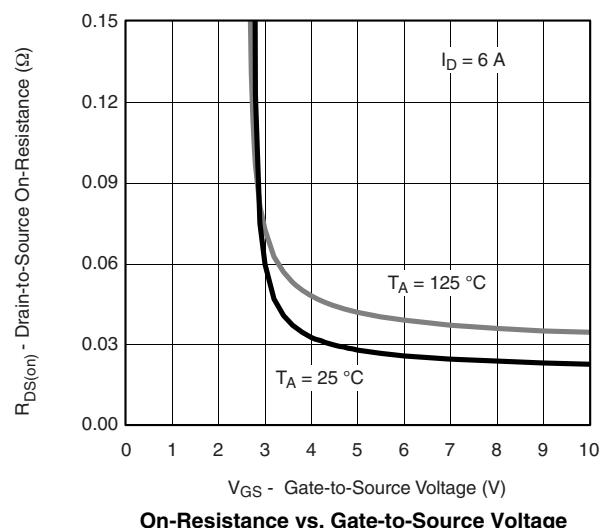
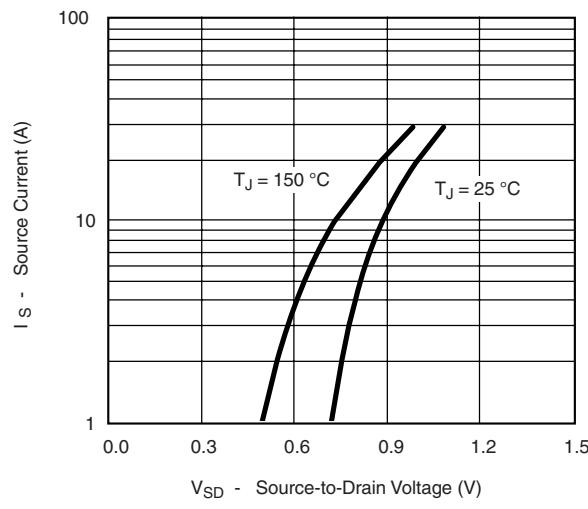
**N-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted


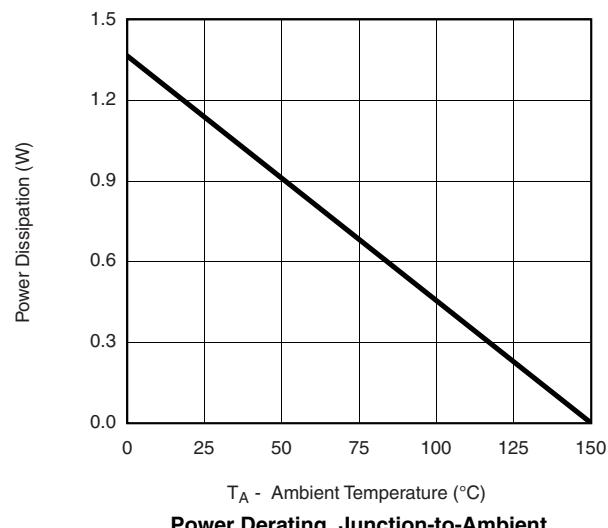
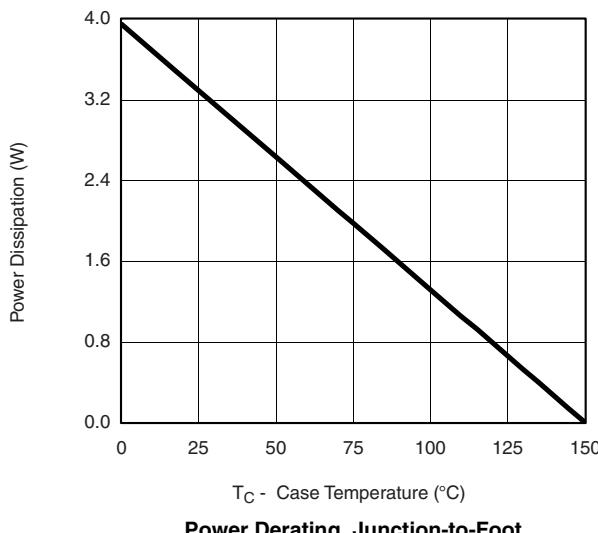
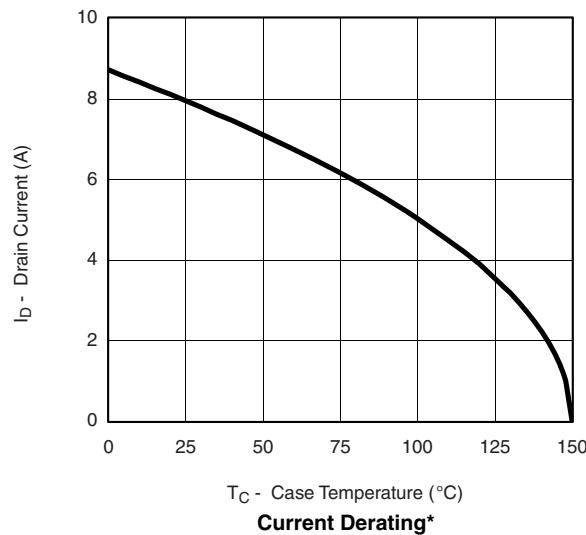
**P-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted



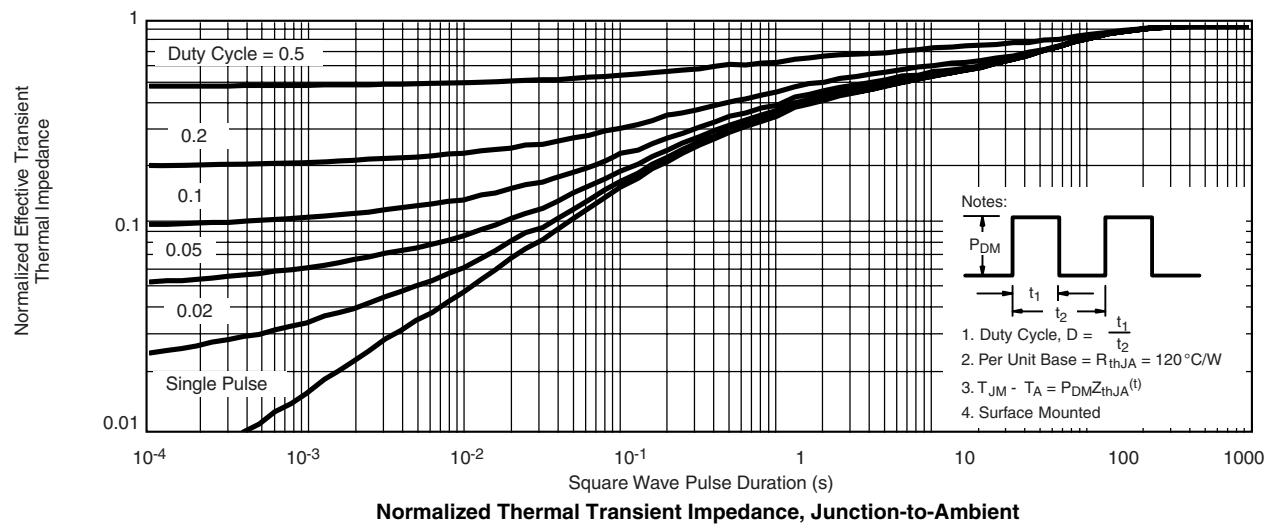
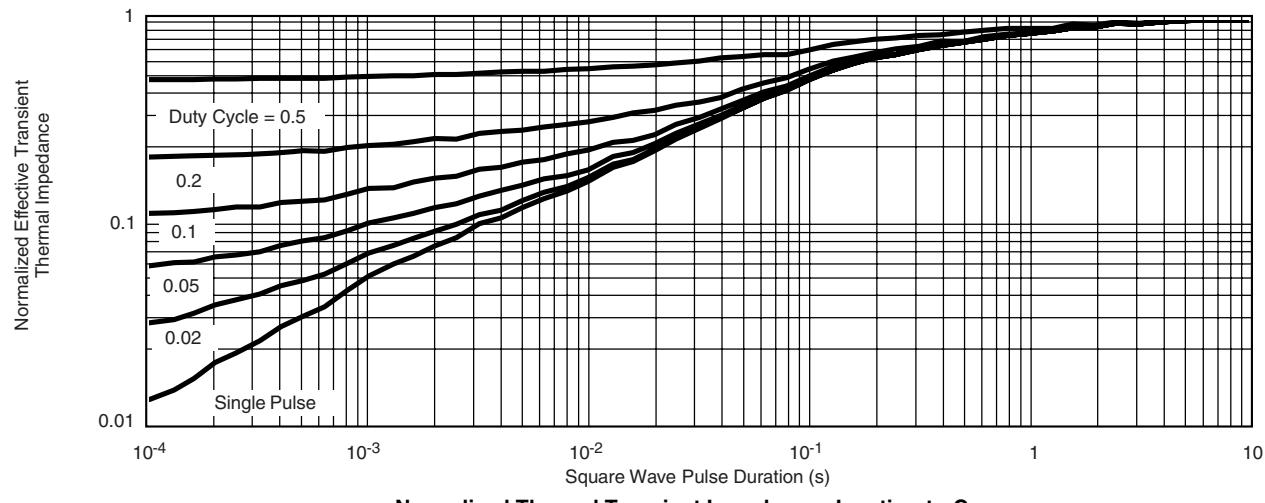
**P-CHANNEL TYPICAL CHARACTERISTICS**

25 °C, unless otherwise noted



**P-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

\* The power dissipation  $P_D$  is based on  $T_{J(\max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

**P-CHANNEL TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted

**Normalized Thermal Transient Impedance, Junction-to-Ambient**

**Normalized Thermal Transient Impedance, Junction-to-Case**

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